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RoHS

COMPLIANT

## **High Stability Thin Film Flat Chip Resistor** ≤ 0.05 % (1000 h rated power at 70 °C)



TNPW e3 Precision Thin Film Flat Chip Resistors are the perfect choice for most fields of modern electronics where highest reliability and stability is of major concern. Typical

### **FEATURES**

- Superior moisture resistivity ≤ 0.25 % (85 °C; 56 days; 85 % RH)
- · Lead (Pb)-free solder contacts, RoHS compliant
- AEC-Q200 compliant (sizes 0402 to 1206)
- · Low temperature coefficient and tight tolerances (± 0.1 %; ± 10 ppm/K)
- Waste gas resistant

### APPLICATIONS

- Test and measuring equipment
- Telecommunication
- Medical equipment
- 材料 886-3-5753170 力 0699
  - 298787

dustrial, medical equ quipment.	TW		0Y.COM	<ul><li>Instrume</li><li>Automoti</li></ul>		胜特力电子(深: Http://ww	则) 86-755-83 w. 100y. com.
STANDARD ELI		SPECIFICA	TIONS	WILL	MM	100Y.C.	WT.N
DESCRIPTION	TNPW0402	TNPW0603	TNPW0805	<b>TNPW1206</b>	TNPW1210 <sup>(1)</sup>	TNPW2010	TNPW2512 <sup>(1)</sup>
Metric size	RR 1005M	RR 1608M	RR 2012M	RR 3216M	RR 3225M	RR 5025M	RR 6332M
Resistance range	10 $\Omega$ to 100 k $\Omega$	10 $\Omega$ to 332 k $\Omega$	10 $\Omega$ to 1 M $\Omega$	10 $\Omega$ to 2 M $\Omega$	10 $\Omega$ to 3.01 $M\Omega$	10 $\Omega$ to 4.99 $M\Omega$	10 Ω to 8.87 MΩ
Resistance tolerance	WT	NN	Yook.	± 1 %; ± 0.5 %;	± 0.1 %	1001.0	WI.Inc
Temperature coefficent	COMT	50 ppm/K; ± 25	ppm/K; ± 15 p	pm/K; ± 10 ppr	n/K	± 50 ppm/K	; ± 25 ppm/K
Climatic category (LCT/UCT/days)	55/125/56	55/125/56	55/125/56	55/125/56	55/125/56	55/125/56	55/125/56
Rated dissipation, $P_{70}^{(2)}$	0.063 W	0.1 W	0.125 W	0.25 W	0.33 W	0.4 W	0.5 W
Operating voltage, U <sub>max.</sub> AC/DC	50 V	75 V	150 V	200 V	200 V	300 V	300 V
Maximum permissible film temperature	155 °C	155 °C	155 °C	155 °C	155 °C	155 °C	155 °C
Thermal resistance (3)	870 K/W	550 K/W	440 K/W	220 K/W	170 K/W	140 K/W	110 K/W
Max. resistance change at $P_{70}$ ; $\Delta R/R$	10 $\Omega$ to 100 k $\Omega$	10 $\Omega$ to 332 k $\Omega$	10 $\Omega$ to 1 M $\Omega$	10 $\Omega$ to 2 M $\Omega$	10 Ω to 3.01 MΩ	10 $\Omega$ to 4.99 M $\Omega$	10 Ω to 8.87 MΩ
1000 h	≤ 0.05 %	≤ 0.05 %	≤ 0.05 %	≤ 0.05 %	≤ 0.05 %	≤ 0.05 %	≤ 0.05 %
8000 h	≤ 0.10 %	≤ 0.10 %	≤ 0.10 %	≤ 0.10 %	≤ 0.10 %	≤ 0.10 %	≤ 0.10 %
225 000 h	≤ 0.30 %	≤ 0.30 %	≤ 0.30 %	≤ 0.30 %	≤ 0.30 %	≤ 0.30 %	≤ 0.30 %
Insulation voltage:	100	M.T		W.10	COW.		WW.100

#### Notes

**FIT**<sub>observed</sub>

Weight/1000 pieces

<sup>(1)</sup> Size not specified in EN 140401-801

U<sub>ins</sub> 1 min

Continuous

<sup>(2)</sup> Rated voltage  $\sqrt{P \times R}$ . The power dissipation on the resistor generates a temperature rise against the local ambient, depending on the heat flow support of the printed-circuit board (thermal resistance). Using advanced temperature level may require special considerations towards the choice of circuit board and solder material. The rated dissipation applies only if the permitted film temperature is not exceeded.

300 V

75 V

≤ 0.1 x 10<sup>-9</sup>/h

10 g

300 V

75 V

≤ 0.1 x 10<sup>-9</sup>/h

16 g

300 V

75 V

≤ 0.1 x 10<sup>-9</sup>/h

28 g

200 V

75 V

≤ 0.1 x 10<sup>-9</sup>/h

5.5 g

(3) Measuring conditions in accordance with EN 140401-801

75 V

75 V

≤ 0.1 x 10<sup>-9</sup>/h

0.65 g

100 V

75 V

≤ 0.1 x 10<sup>-9</sup>/h

2 g

TNPW 0402 without marking

300 V

75 V

≤ 0.1 x 10<sup>-9</sup>/h

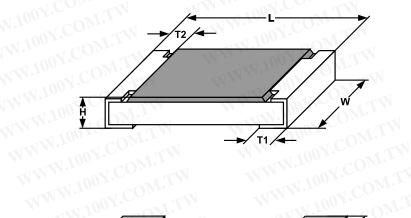
39 g

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	SIZE	CON.	DIMENSIONS	3 in millimeter	S	
INCH	METRIC	- LN	W	Н	T1	T2
0402	1005	$1.0 \pm 0.05$	$0.5 \pm 0.05$	$0.35 \pm 0.05$	0.2 ±	0.10
0603	1608	1.6 ± 0.10	0.85 ± 0.10	$0.45 \pm 0.10$	0.3 ±	0.20
0805	2012	2.0 ± 0.15	1.25 ± 0.15	0.45 ± 0.10	0.4 ±	0.20
1206	3216	$3.2 \pm 0.15$	1.6 ± 0.15	$0.55 \pm 0.10$	0.5 ±	0.25
1210	3225	3.2 ± 0.15	2.45 ± 0.15	$0.60 \pm 0.15$	0.5 ±	0.25
2010	5025	5.0 ± 0.15	2.5 ± 0.15	0.60 ± 0.15	0.6 ±	0.25
2512	6332	$6.3 \pm 0.20$	3.1 ± 0.15	0.60 ± 0.15	0.6 ±	0.25

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1	SOL	DER PA	D DIME	NSIONS	in millim	eters	
	SIZE	REFLC	W SOLD	DERING	WAV	E SOLDE	RING
INCH	METRIC	а	b		а	b	I
0402	1005	0.4	0.6	0.5	-1	N -	-
0603	1608	0.5	0.9	1.0	0.9	0.9	1.0
0805	2012	0.7	1.3	1.2	0.9	1.3	1.3
1206	3216	0.9	1.7	2.0	1.1	1.7	2.3
1210	3225	0.9	2.5	2.0	1.1	2.5	2.3
2010	5025	1.0	2.5	3.9	1.2	2.5	3.9
2512	6332	1.0	3.2	5.2	1.2	3.2	5.2

勝特力材料 886-3-5753170 胜特力电子(上海) 86-21-34970699 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw

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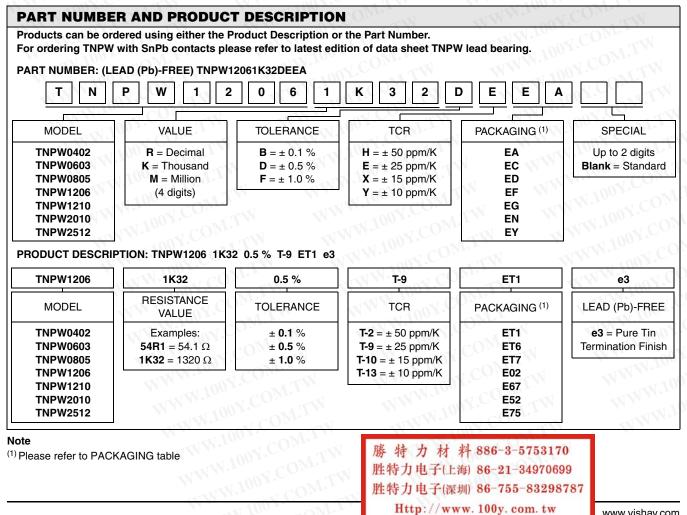
<b>FEMPERATURE</b> (			E KAI			WW		ov.C		
TYPE	TCR	TOLERANCE	CON	RES		E VALU	E	~ / /	-SERIES	
	WT II	±1%		NTN.	10R to		1	001.3	24 to 96	1
	± 50 ppm/K	± 0.5 %			10R to		N VY		4 to 192	Wr.
TNPW0402	T.M.	± 0.1 %		M.L	47R to		-	Jue		1.
	L.COM TW	±1%	1.0		10R to				24 to 96	T
	± 25 ppm/K	± 0.5 %	, . C	OV.,	10R to	100K				
	N. V.	± 0.1 %	01.0	110			VN T		4 to 192	M
	± 15 ppm/K	± 0.1 %	×1	COM.	47R to	100K	WW	N	10 192	Un
NVY I	± 10 ppm/K	± 0.1 %		Ma	1.1			.w.1	JU * .	Mos
WW.	N.COm and	±1%	-		10R to 3	332K	N		24 to 96	
	± 50 ppm/K	± 0.5 %	100	100	10R to 3	332K			4 to 192	CON
	N.V.	± 0.1 %	100							
NPW0603	The CONT.	±1%	N.1.	10R to 332K		24 to 96				
	± 25 ppm/K	± 0.5 %				W.100 -				
	N.r. COM	± 0.1 %	11.	J.V.	101110				4 to 192	NY.C
	± 15 ppm/K	± 0.1 % ± 0.1 %		UV -	47R to 3	332K		2	-10 192	-16
	± 10 ppm/K			. Noo.				NY		001.
	N.IV. COM	±1%	N	.10-	10R to	1M0	T		24 to 96	
	± 50 ppm/K	± 0.5 %		1 100X	10R to	1M0		0	4 to 192	100 1
	M.W.	± 0.1 %	W			N	1			
NPW0805	1001.	±1%		x100	10R to	1M0		2	24 to 96	1.100
	± 25 ppm/K	± 0.5 %	VV	10R to 1M0 47R to 1M0		N I				
	·	± 0.1 %				-	0	4 to 192	11.10	
	± 15 ppm/K	± 0.1 %	N			TW				
	± 10 ppm/K	± 0.1 %		NN.					-	N M.
	N 1007	±1%			10R to	2M0	V. 1	24 to 96		
	± 50 ppm/K	± 0.5 %	-	NN	10R to	2M0		24 to 192		
	100	± 0.1 %				$N_{1}$				
NPW1206	WW 100	±1%		NV.	10R to	2M0			24 to 96	
	± 25 ppm/K	± 0.5 %		WIX	10R to	2M0 C	Ow			
		± 0.1 %			101110		A.	2	4 to 192	,
	± 15 ppm/K	± 0.1 %	[	W	47R to	2M0		2		
	± 10 ppm/K	± 0.1 %			11110	LIVIO				



### High Stability Thin Film Flat Chip Resistor $\leq$ 0.05 % (1000 h rated power at 70 °C)

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TEMPERATUR	RE COEFFICIENT AN	D RESISTANCE RAI	NGE		
TYPE	TCR	TOLERANCE	RESISTANCE VALUE	E-SERIES	
No.	NAM. SALCO	±1%	10R to 3M01	24 to 96	
	± 50 ppm/K	± 0.5 %	10R to 3M01	04 to 100	
	WWW MODY.CC	± 0.1 %	47R to 2M13	24 to 192	
TNPW1210	N. M. March	±1%	10R to 3M01	24 to 96	
	± 25 ppm/K	± 0.5 %	10R to 3M01	24 to 192	
	WWW.	± 0.1 %	NT. O.Y.O.		
	± 15 ppm/K	± 0.1 %	47R to 2M13	24 10 192	
	± 10 ppm/K	± 0.1 %	The story of the second		
CONT	.10-	±1%	10R to 4M99	24 to 96	
	± 50 ppm/K	± 0.5 %	10R to 4M99	24 to 192	
TNPW2010	NWW.1	± 0.1 %	47R to 1M0	24 10 192	
	10	±1%	10R to 4M99	24 to 96	
	± 25 ppm/K	± 0.5 %	10R to 4M99	- 24 to 192	
		± 0.1 %	47R to 1M0		
1002.COM.TN		±1%	10R to 8M87	24 to 96	
	± 50 ppm/K	± 0.5 %	10R to 8M87 47R to 1M0		
	T. N	± 0.1 %			
TNPW2512	WW KN	±1%	10R to 8M87	24 to 96	
	± 25 ppm/K	± 0.5 %	10R to 8M87	04 to 100	
	NW WY	± 0.1 %	47R to 1M0	24 to 192	



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# High Stability Thin Film Flat Chip Resistor $\leq 0.05 \%$ (1000 h rated power at 70 °C)

PACKAGI	NG						
MODEL	TAPE WIDTH [mm]	PITCH [mm]	REEL DIAMETER [mm/inch]	PIECES PER REEL	PACKAGING CODE FOR PRODUCT DESCRIPTION	PACKAGING CODE FOR PART NUMBER	TYPE OF CARRIER TAPE
TNPW0402	8	2	180/7	10 000	ET7	ED	Paper
TNPW0603 TNPW0805 TNPW1206 TNPW1210	8	4	180/7	1000	E52 <sup>(1)</sup>	EN (1)	Paper
TNPW0603 TNPW0805 TNPW1206 TNPW1210	8	4	180/7	5000	ET1N.10	EA	Paper
TNPW0603 TNPW0805 TNPW1206 TNPW1210	8	4	330/13	20 000	ET6	EC	Paper
TNDWOOLC	10	4	100/7	1000	E75	EY	Blister
TNPW2010	12	4	180/7	4000	E02	EF	Blister
	12	4	190/7	1000	E75	EY	Blister
TNPW2512	LCU12 av	4	180/7	2000	E67	EG	Blister

Note

<sup>(1)</sup> E52/EN only for precision resistors with tolerance  $\pm$  0.1 % and temperature coefficient  $\leq \pm$  25 ppm/K

### DESCRIPTION

Production is strictly controlled and follows an extensive set of instructions established for reproducibility. A homogeneous film of metal alloy is deposited on a high grade Al<sub>2</sub>O<sub>3</sub> ceramic substrate and conditioned to achieve the desired temperature coefficient. Specially designed inner contacts are deposited on both sides. A special laser is used to achieve the target value by smoothly fine trimming the resistive layer without damaging the ceramics. A further conditioning is applied in order to stabilize the trimming result. The resistor elements are covered by a protective coating designed for electrical, mechanical and climatic protection. The terminations receive a final pure tin on nickel plating. The result of the determined production is verified by an extensive testing procedure on 100 % of the individual chip resistors. This includes pulse load screening for the elimination of products with a potential risk of early life failures according to EN 140401-801, 2.1.2.2. Only accepted products are laid directly into the tape in accordance with EN 60286-3.

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### ASSEMBLY

The resistors are suitable for processing on automatic SMD assembly systems. They are suitable for automatic soldering using wave, reflow or vapour phase as shown in **IEC 61760-1**. Excellent solderability is proven, even after extended storage in excess of 10 years. The encapsulation is resistant to all cleaning solvents commonly used in the electronics industry, including alcohols, esters and aqueous solutions. The suitability of conformal coatings, if applied, shall be qualified by appropriate means to ensure the long-term stability of the whole system. The resistors are RoHS compliant, the puretin plating provides compatibility with lead (Pb)-free and lead-containing soldering processes. The immunity of the plating against tin whisker growth has been proven under extensive testing.

All products comply with the **GADSL**<sup>(2)</sup> and the **CEFIC-EECA-EICTA**<sup>(3)</sup> list of legal restrictions on hazardous substances. This includes full compliance with the following directives:

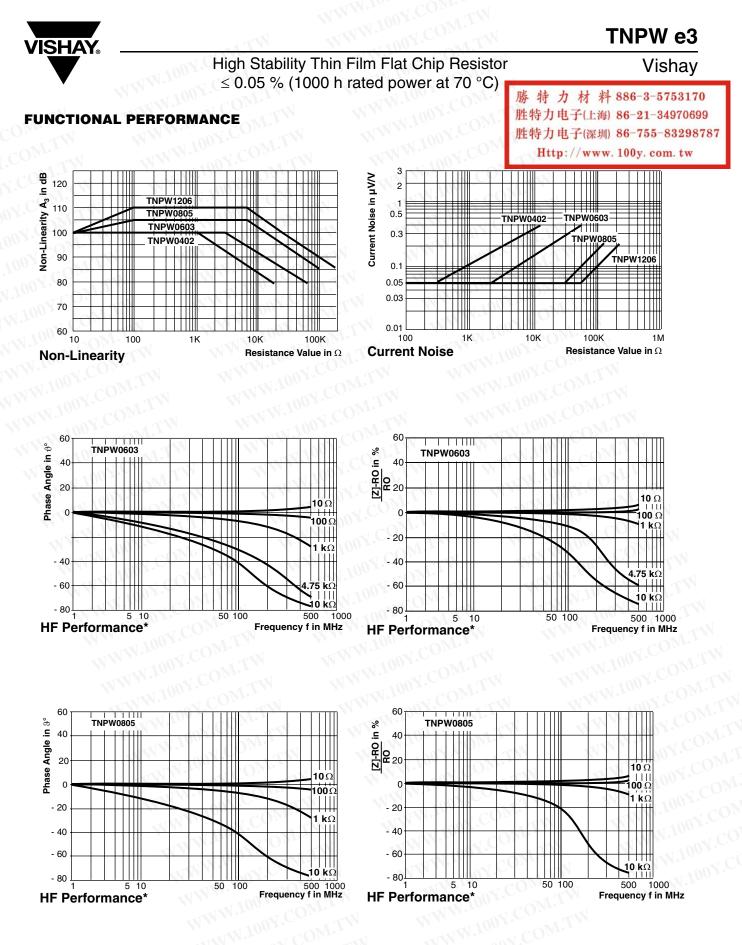
- 2000/53/EC End of Vehicle life Directive (ELV) and Annex II (ELV II)
- 2002/95/EC Restriction of the use of Hazardous Substances Directive (RoHS)
- 2002/96/EC Waste Electrical and Electronic Equipment Directive (WEEE)

Solderability is specified for 2 years after production or re-qualification. The permitted storage time is 20 years.

#### Notes

<sup>(2)</sup> Global Automotive Declarable Substance List, see <u>www.gadsl.org</u>

<sup>&</sup>lt;sup>(3)</sup> CEFIC (European Chemical Industry Council), EECA (European Electronic Component Manufacturers Association), EICTA (European trade organisation representing the information and communications technology and consumer electronics), see <u>www.eicta.org</u>  $\rightarrow$  issue  $\rightarrow$  environment policy  $\rightarrow$  chemicals  $\rightarrow$  chemicals for electronics

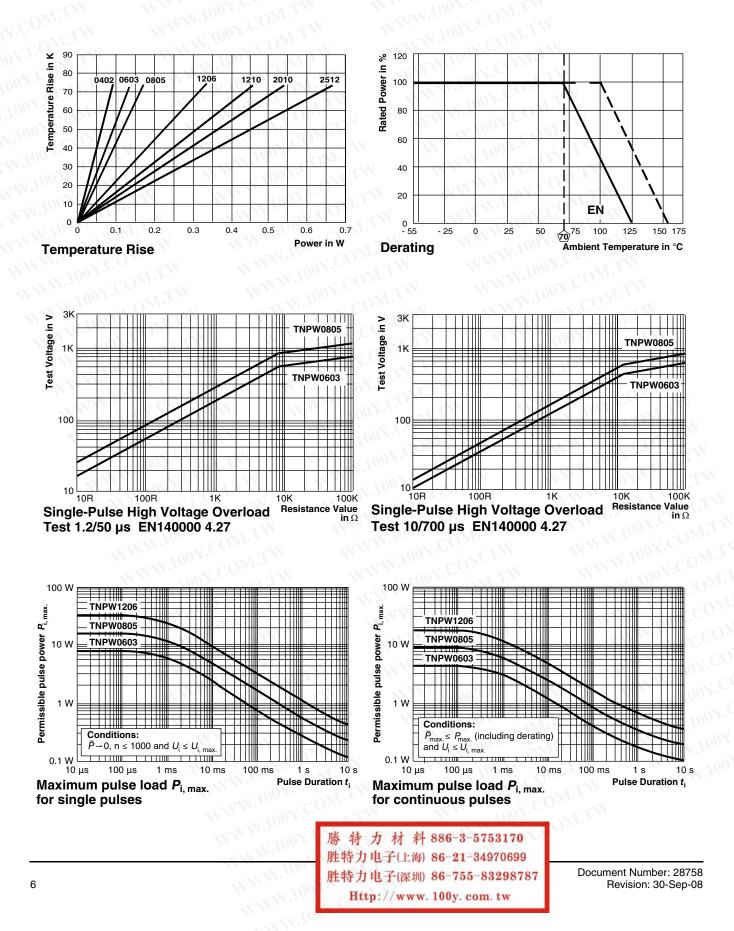


<sup>\*</sup> Typical figures. HF-characteristic also depends on termination and circuit design.

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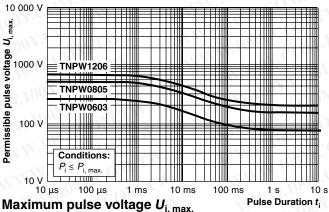
# High Stability Thin Film Flat Chip Resistor

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 $\leq$  0.05 % (1000 h rated power at 70 °C)



### **TEST AND REQUIREMENTS**

All tests are carried out in accordance with the following specifications:

EN 60115-1, Generic specification (includes tests)

EN 140400, Sectional specification (includes schedule for qualification approval)

EN 140401-801, Detail specification (includes schedule for conformance inspection)

The following table contains only the most important tests. For the full test schedule refer to the documents listed above. The testing also covers most of the requirements specified by EIA/IS-703 and JIS-C-5202. The tests are carried out in accordance with IEC 60068 and under standard atmospheric conditions in accordance with IEC 60068-1, 5.3. Climatic category LCT/UCT/56 (rated temperature range: Lower

Category Temperature, Upper Category Temperature; damp heat, long term, 56 days) is valid. Unless otherwise specified the following values apply:

Temperature: 15 °C to 35 °C Relative humidity: 45 % to 75 %

Air pressure: 86 kPa to 106 kPa (860 mbar to 1060 mbar).

The components are mounted for testing on boards in accordance with EN 60115-1, 4.31 unless otherwise specified. The parameters stated in the Test Procedures and Requirements table are based on the required tests and permitted limits of EN 140401-801. However, some additional tests and a number of improvements against those minimum requirements have been included.

TEST PR	OCEDURES	AND REQU	REMENTS	
EN 60115-1 CLAUSE	IEC 60068-2 TEST METHOD	TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE
	KOOL WW	WT	Stability for product types:	MIN WWW WILLOOT.C
	WWW.Ioo	V.COM.	TNPW0402	
	WW.100	COM.1	TNPW0603	
	WW 10	OT.COM.J	TNPW0805	
	WWW	nov.co.	TNPW1206	
	WWW.	N.COM	TNPW1210	
	WW	Too CON	TNPW2010	
		1.1001.0	TNPW2512	100 L. COWLIN
4.5	-AM	Resistance	MIN WI	± 1 %; ± 0.5 %; ± 0.1 %
4.8.4.2	- 44	Temperature coefficient	At 20/- 55/20 °C ± and 20/125/20 °C	± 50 ppm/K; ± 25 ppm/K; ± 15 ppm/K; ± 10 ppm/K
4.25.1	- 1	Endurance at 70 °C	$U = \sqrt{P_{70} \times R} \text{ or}$ $U = U_{\text{max}};$ whichever is the less severe; 1.5 h on; 0.5 h off;	WW.100Y.COM.TW WWW.
		W 100	70 °C; 1000 h	± (0.05 % <i>R</i> + 0.01 Ω)
		WWW	70 °C; 8000 h	± (0.1 % <i>R</i> + 0.02 Ω)

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EN 60115-1 CLAUSE	IEC 60068-2 TEST METHOD	TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE
-0M.,		WW.100 V	Stability for product types:	
	N 71	W.100 1.	TNPW0402	勝特力材料 886-3-5753170
	W W	100Y	TNPW0603	胜特力电子(上海) 86-21-34970699
	· Wo	WWW.	TNPW0805	胜特力电子(深圳) 86-755-83298787
		WW.W	TNPW1206	Http://www.100y.com.tw
	I.TW	W	TNPW1210	ALL COMPANY
	WIN	WW.	TNPW2010	
N.CU	WT	WWW.	TNPW2512	NWWW. 100X.CO. M.TW
4.25.3	ONL.TW	Endurance at upper category temperature	125 °C; 1000 h 155 °C; 1000 h	$\pm$ (0.05 % <i>R</i> + 0.01 Ω) $\pm$ (0.1 % <i>R</i> + 0.02 Ω)
4.24	78 (Cab)	Damp heat, steady state	(40 ± 2) °C; 56 days; (93 ± 3) % RH	± (0.1 % <i>R</i> + 0.01 Ω)
4.23	COM.TW	Climatic sequence:	WW.100Y.COM.TW	WWW.1002.COM.TW
4.23.2	2 (Ba)	Dry heat	UCT; 16 h	
4.23.3	30 (Db)	Damp	55 °C; 24 h; > 90 % RH; 1 cycle	
4.23.4	1 (Aa)	Cold	LCT; 2 h	± (0.1 % <i>R</i> + 0.02 Ω)
4.23.5	13 (M)	Low air	8.5 kPa; 2 h; 25 ± 10 °C	$\pm (0.1 \% \pi + 0.02 s_{2})$
4.23.6	30 (Db)	Damp heat, cyclic	55 °C; 5 days; > 95 to 100 % RH; 5 cycles	
4.23.7	W.100X.C	D.C. load	$U = \sqrt{P_{70} \times R} \le U_{\text{max.}}; 1 \text{ min}$ LCT = - 55 °C UCT = 125 °C	LTW WWW.100Y.COM.TV
	1 (Aa)	Cold	- 55 °C; 2 h	± (0.05 % <i>R</i> + 0.01 Ω)
4.19	14 (Na)	Rapid change of temperature	30 min at LCT and 30 min at UCT; LCT = - 55 °C; UCT = 125 °C; 1000 cycles	± (0.1 % <i>R</i> + 0.01 Ω)
4.13	WWW.1	Short time overload	$U = 2.5 \times \sqrt{P_{70} \times R} \text{ or}$ $U = 2 \times U_{\text{max.}}; \text{ whichever is the}$ less severe; 5 s	± (0.05 % <i>R</i> + 0.01 Ω)
4.27	MMA MMA	Single pulse high voltage overload	Severity no. 4: $U = 10 \times \sqrt{P_{70} \times R}$ or $U = 2 \times U_{max.}$ ; whichever is the less severe; 10 pulses 10 µs/700 µs	± (0.5 % <i>R</i> + 0.05 Ω) no visible damage
4.37	4 14 - 14 17	Periodic electric overload	$U = \sqrt{15 \times P_{70} \times R} \text{ or}$ $U = 2 \times U_{max.};$ whichever is the less severe; 0.1 s on; 2.5 s off; 1000 cycles	± (0.5 % <i>R</i> + 0.05 Ω) no visible damage
4.22	6 (Fc)	Vibration	Endurance by sweeping; 10 to 2000 Hz; no resonance; amplitude $\leq$ 1.5 mm or $\leq$ 200 m/s <sup>2</sup> ; 6 h	± (0.05 % <i>R</i> + 0.01 Ω) no visible damage

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TEST PR	OCEDURES	AND REQUI	REMENTS	
EN 60115-1 CLAUSE	IEC 60068-2 TEST METHOD	TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE
0 <sup>M.1</sup>		N.100 CC	Stability for product types:	V.LOW TW
	W.	W.1001.C	TNPW0402	
	AN AN	100Y.C	TNPW0603	
	W W	WW. TOOY!	TNPW0805	
		WW.IO	TNPW1206	
		W.100	TNPW1210	
	TW	WW 100	TNPW2010	
NY.COM	WT.	WW	TNPW2512	WWWWWWWWWWWWWWWWWWWWWWWWWWWWWW
100Y.CO	MITW	WWW.I	Solder bath method; SnPb40; non-activated flux $(215 \pm 3)$ °C; $(3 \pm 0.3)$ s	Good tinning (≥ 95 % covered);
4.17.2	58 (Td)	Solderability	Solder bath method; SnAg3Cu0.5 or SnAg3.5; non-activated flux (235 ± 3) °C; (2 ± 0.2) s	no visible damage
4.18.2	58 (Td)	Resistance to soldering heat	Solder bath method; (260 $\pm$ 5) °C; (10 $\pm$ 1) s	± (0.02 % <i>R</i> + 0.01 Ω)
4.29	45 (XA)	Component solvent resistance	lsopropyl alcohol + 50 °C; method 2	No visible damage
4.32	21 (112.)	Shear	RR 1005M and RR 1608M; 9 N	No visible damage
4.32	21 (Ue <sub>3</sub> )	(adhesion)	RR 2012M and RR 3216M: 45 N	No visible damage
4.33	21 (Ue <sub>1</sub> )	Substrate bending	Depth 2 mm, 3 times	$\pm$ (0.05 % $R$ + 0.01 $\Omega$ ) no visible damage, no open circuit in bent position
4.7	W.100	Voltage proof	$U_{\rm rms} = U_{\rm ins}; 60 \pm 5  {\rm s}$	No flashover or breakdown
4.35	WW.100 1.	Flammability	IEC 60695-11-5, needle flame test; 10 s	No burning after 30 s
-	NWW.100Y	Damp heat	(85 ± 5) °C; 56 days (85 ± 5) % RH	± (0.25 <i>R</i> + 0.05 Ω)

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### **APPLICABLE SPECIFICATIONS**

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